LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司

Winstar Display Co., LTD 華凌光電股份有限公司



WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

CUSTOMER:	
MODULE NO.:	WO24064A1-TMI#

AP	PR	OV	ED	BY:
		\smile \mathbf{v}		

(FOR CUSTOMER USE ONLY)

PCB VERSION:

DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
			4

VERSION	DATE	REVISED PAGE NO.	SUMMAR	RY
			Modify	the
K	2024/11/14		recommended	soldering
			temperature	



MODLE NO:

華凌光電股份有限公司

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2011/03/29		First issue
Α	2011/08/15		Correct Electrical
			Characteristics.
В	2015/03/16		Modify Response Time
			&contour drawing.
C	2015/06/17		Modify Length of Cable.
D	2016/01/27	\C	Modify Precautions in use
			of LCD Modules
			& Static electricity test
Е	2016/11/21		Add FPC bending rule
F	2019/08/27		Modify Material List of
	167		Components for RoHs
G	2019/12/17		Modify Precautions in use
			of LCD Modules
H	2020/07/23		Correct Duty
I	2022/02/10		Add interface
			Modify LCD & B/L
			information
J	2023/01/31		Modify B/L information

K	2024/11/14	Modify the recommended
		soldering temperature



Contents

- 1.Module Classification Information
- 2. Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
- 8. Contour Drawing & Block Diagram
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage



1. Module Classification Information

D Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 240 * 64 dot

Model serials no.

 $B\rightarrow EL$, Blue green $A\rightarrow LED$, Amber $J\rightarrow DIP$ LED, Blue $D\rightarrow EL$, Green $R\rightarrow LED$, Red $K\rightarrow DIP$ LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow$ EL, Yellow Green $G\rightarrow$ LED, Green $H\rightarrow$ DIP LED, Amber $F\rightarrow$ CCFL, White $P\rightarrow$ LED, Blue $I\rightarrow$ DIP LED, Red

 $Y\rightarrow$ LED, Yellow Green $X\rightarrow$ LED, Dual color $G\rightarrow$ LED, Green $C\rightarrow$ LED, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

H→ HTN Positive, Gray F→FSTN Positive
I→HTN Negative, Black K→FSC Negative
U→HTN Negative, Blue S→FSC Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

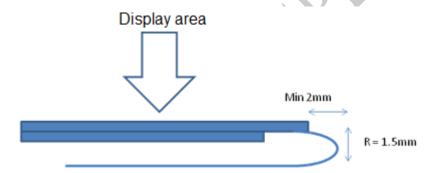
Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00 direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code #:Fit in with the ROHS Directions and regulations

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11) The limitation of FPC bending



(12)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.



3.General Specification

Item	Dimension	Unit
Number of dots	240 x 64	_
Module dimension	142.5 x 51.7 x 14.9 (MAX)	mm
View area	130.2 x 37.6	mm
Active area	127.17 x 33.89	mm
Dot size	0.50 x 0.50	mm
Dot pitch	0.53 x 0.53	mm
LCD type	STN Negative, Blue Transmissive (In LCD production, It will occur slightly color of can only guarantee the same color in the same based on	
Duty	1/65	
View direction	6 o'clock	
Backlight Type	LED White	
IC	ST7565P	. /
Interface	6800/8080/4-Line SPI	

4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}$ C
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}$ C
Power Supply Voltage	VDD	-0.3	_	3.6	V
Power supply voltage (VDD standard)	V0, VOUT	-0.3	_	14.5	V
Power supply voltage (VDD standard)	V1, V2, V3, V4	-0.3	<u> </u>	V0+0.3	V

5.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	VDD-VSS	_	3.0	3.3	3.6	V
		Ta=-20°C	_	_	_	V
Supply Voltage For LCM	Vo-V _{SS}	Ta=25°C	10.7	11.0	11.3	V
		Ta=70°C	_	_	<- X	V
Input High Volt.	VIH	_	$0.8~\mathrm{V_{DD}}$	_	V _{DD}	V
Input Low Volt.	VIL	_	Vss	~C	$0.2~\mathrm{V_{DD}}$	V
Output High Volt.	VOH	_	$0.8~\mathrm{V_{DD}}$		$V_{ m DD}$	V
Output Low Volt.	VOL	_	Vss	_	$0.2V_{\mathrm{DD}}$	V
Supply Current(No include LED Backlight)	IDD	V _{DD} =3.3V		1.5	2.5	mA

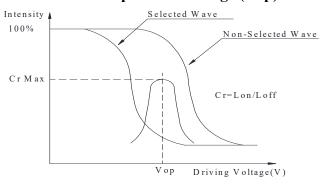
Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.



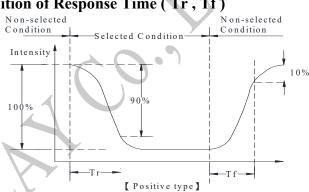
6.Optical Characteristics

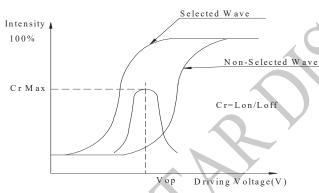
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	20	$\phi = 180^{\circ}$
View Angle	θ	CR≧2	0	_	40	$\phi = 0^{\circ}$
	θ	CR≧2	0	_	30	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	30	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	3	_	_
ъ т.	T rise	_	_	200	300	ms
Response Time	T fall	_	_	250	350	ms

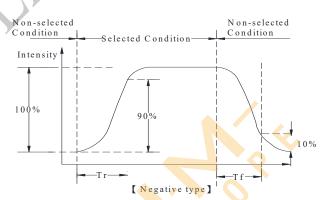
Definition of Operation Voltage (Vop)



Definition of Response Time (Tr, Tf)







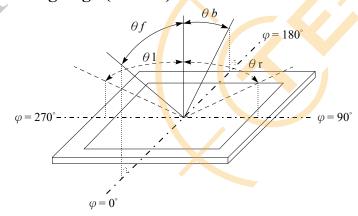
Conditions:

Operating Voltage: Vop

Viewing Angle(θ , φ): 0° , 0°

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

Definition of viewing angle($CR \ge 2$)

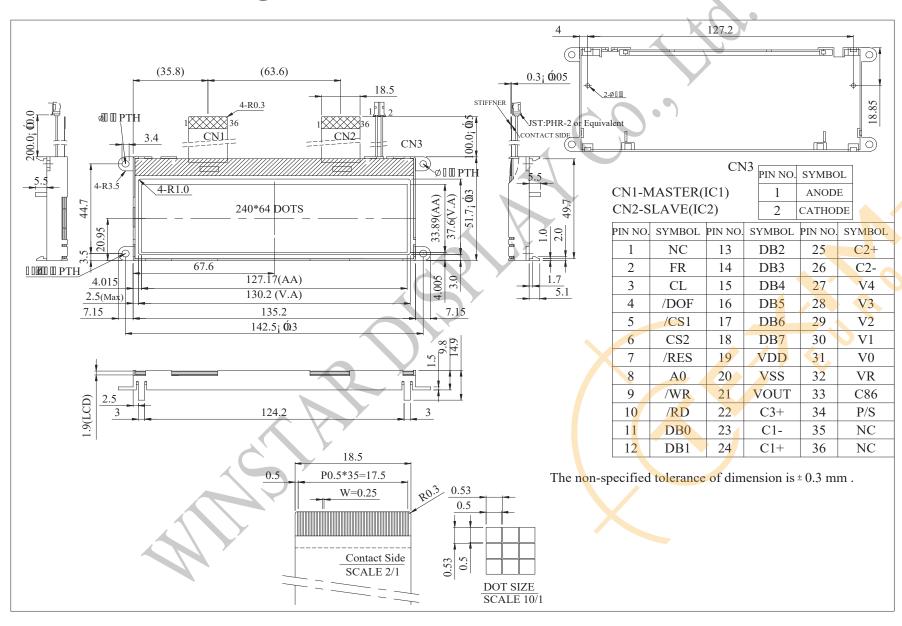


7.Interface Pin Function

Pin No.	Symbol	Level	Description		
1	NC		No connection		
2	FR	О	This is the liquid crystal alternating current signal terminal.		
3	CL	I/O	This is the display clock input terminal The following is true depending on the M/S and CLS status.		
4	/DOF	О	This is the LCD blanking control terminal.		
5	/CS1	I	This is the chip select signal. When $/CS1 = "L"$ and $CS2 = "H"$,		
6	CS2	I	then the chip Select becomes active, and data/command I/O is enabled.		
7	/RES	I	When /RES is set to "L", the register settings are initialized (cleared). The reset operation is performed by the /RES signal level.		
8	A0	I	This is connect to the least significant bit of the normal MPU address bus, and it determines whether the data bits are data or command. A0 = "H": Indicates that D0 to D7 are display data. A0 = "L": Indicates that D0 to D7 are control data.		
9	/WR	I	When connected to 8080 series MPU, this pin is treated as the "/WR" signal of the 8080 MPU and is LOW-active. The signals on the data bus are latched at the rising edge of the /WR signal. When connected to 6800 series MPU, this pin is treated as the "R/W" signal of the 6800 MPU and decides the access type: When R/W = "H": Read. When R/W = "L": Write.		
10	/RD	PI	When connected to 8080 series MPU, this pin is treated as the "/RD" signal of the 8080 MPU and is LOW-active. The data bus is in an output status when this signal is "L". When connected to 6800 series MPU, this pin is treated as the "E" signal of the 6800 MPU and is HIGH-active. This is the enable clock input terminal of the 6800 Series MPU.		
11~18	DB0~DB7	I/O	Data bus		
19	$V_{ m DD}$	P	Power supply		
20	V _{SS}	P	Ground		
21	Vout	0	DC/DC voltage converter. Connect a capacitor between this terminal and VSS or VDD		
22	C3+		DC/DC vialtage acquirement		
23	C1- O		DC/DC voltage converter		

24	C1+	
25	C2+	
26	C2-	
27	V4	This is a multi-level power supply for the liquid crystal drive. The voltage
28	V3	Supply applied is determined by the liquid crystal cell, and is changed
29	V2	through the use of a resistive voltage divided or through changing the
30	V1	P impedance using an op. amp.
31	V0	Voltage levels are determined based on Vss, and must maintain the relative magnitudes shown below. $V0 \ge V1 \ge V2 \ge V3 \ge V4 \ge Vss$
32	VR	Output voltage regulator terminal. Provides the voltage between VSS and V0 through a resistive voltage divider. IRS = "L": the V0 voltage regulator internal resistors are not used. IRS = "H": the V0 voltage regulator internal resistors are used.
33	C86	This is the MPU interface selection pin. I C86 = "H" : 6800 Series MPU interface. C86 = "L" : 8080 Series MPU interface.
34	P/S	This pin configures the interface to be parallel mode or serial mode. P/S = "H" : Parallel data input/output. P/S = "L" : Serial data input. The following applies depending on the P/S status: P/S Data/Command Data Read/Write Serial Clock "H" A0 D0 to D7 /RD, /WR X "L" A0 SI (D7) Write only SCL (D6) When P/S = "L" , D0 to D5 must be fixed to "H" . /RD (E) and /WR (R/W) are fixed to either "H" or "L" . The serial access mode does NOT support read operation.
35	NC C	No connection
36	NC	No connection

8.Contour Drawing



9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test		
Test Item	Content of Test	Test Condition	Not e
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs ▲	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation $-20^{\circ}\text{C} \qquad 25^{\circ}\text{C} \qquad 70^{\circ}\text{C}$ 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS= ± 600 V(contact), ± 800 v(air), RS= 330Ω CS= 150 pF 10 times	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

Specification

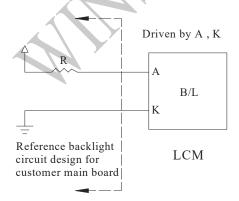
Parameter	Symbol	Min	Тур	Max	Unit	Test Condition	
Supply Current	ILED	35	112	140	mA	V= 3.5 V(Note 1)	
Supply Voltage	V	3.4	3.5	3.6	V	_	
Reverse Voltage	VR	_	_	5	V	2	
Calamana	X	0.255	0.285	0.315	_	V. 25V	
Colour coordinate	Y	0.265	0.295	0.325	_	V= 3.5 V	
Luminance	IV	1440	1800	_	ad/m²	V= 3,5 V	
(Without LCD)	1 V	1440	1000		cu/III-	V=3.5 V	
LED Life Time						ILED=112 mA	
(For Reference	_	_	50K	(-)	Hr.	25℃,50-60%RH,	
only)						(Note 2)	
Color	White		(5)	Y			

Note: A backlight driven by voltage will keep the drive current under the safe area (current between minimum and maximum).

If the B/L LED is driven by current only, the drive voltage cannot be considered as a reference value.

Note 1: Supply current minimum value is only for reference since LED brightness efficacy keeps enhancing. Current consumption becomes less and less to achieve the same luminance.

Note 2:50K hours is only an estimate for reference.



11.Inspection specification

No	Item			Criterion		AQL
		Missing vertical,	horizonta	ıl segment, segment	contrast defect.	
		Missing characte	r, dot or i	icon.		
		Display malfunct	tion.			
01	Electrical	No function or no	o display.			0.65
01	Testing	Current consump	tion exce	eds product specific	eations.	0.03
		LCD viewing ans	gle defect		~ (
		Mixed product ty	pes.			
		Contrast defect.				
	Black or white	2.1 White and bla	ack spots	on display ≤ 0.25 m	m, no more than	
02	spots on LCD	three white or bla	ack spots	present.		2.5
	(display only)	2.2 Densely spac	ed: No me	ore than two spots o	or lines within 3mm	
		3.1 Round type:	As follow	ving drawing		
		$\Phi = (x + y) / 2$				
		X		Size	Acceptable QTY	
		7	L., 1	Φ≦0.10	Accept no dense	2.5
		7	F Y	$0.10 < \Phi \le 0.20$	2	
	LCD black spots,			$0.20 < \Phi \leq 0.25$	1	
03	white spots,			0.25 < Ф	0	
	contamination	3.2 Line type : (<i>A</i>	As followi	ng drawing)		
	(non-display)	X Y Y		****	Acceptable Q	
		_ /¥ w	Length	Width	TY	9
		→ L +-		W≦0.02	Accept no dense	2.5
			L≦3.0	$0.02 < W \le 0.03$		
			L≦2.5	$0.03 < W \le 0.05$	2	
				0.05 < W	As round type	
			_			
		If bubbles are vis	sible,	Size Φ	Acceptable Q TY	
		judge using black	s spot	$\Phi \leq 0.20$	Accept no dense	
04	Polarizer bubbles	specifications, no	ot easy	$0.20 < \Phi \leq 0.50$	3	2.5
		to find, must che	ck in	$0.50 < \Phi \le 1.00$	2	
		specify direction.		1.00 < Φ	0	
				Total Q TY	3	

No	Item	Criterion	AQL
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination	
		Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length:	
		6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:	,•
		z: Chip thickness y: Chip width x: Chip length	
06	Chipped	$Z \le 1/2t$ Not over viewing area $x \le 1/8a$	2.5
06	glass	$1/2t < z \le 2t \qquad \qquad \text{Not exceed } 1/3k \qquad \qquad x \le 1/8a$	2.5
		 ⊙ If there are 2 or more chips, x is total length of each chip. 6.1.2 Corner crack: 	2
	19	z: Chip thickness y: Chip width x: Chip length	
		$Z \le 1/2t$ Not over viewing $x \le 1/8a$	
		$1/2t < z \le 2t$ Not exceed 1/3k $x \le 1/8a$	
		⊙ If there are 2 or more chips, x is the total length of each chip.	

No	Item	Criterion	AQL
110	Item		AQL
		Symbols:	
		x: Chip length y: Chip width z: Chip thickness	
		k: Seal width t: Glass thickness a: LCD side length	
		L: Electrode pad length	
		6.2 Protrusion over terminal:	
		6.2.1 Chip on electrode pad :	
		Z	•
		y: Chip width x: Chip length z: Chip thickness	
		$y \le 0.5 \text{mm} \qquad \qquad x \le 1/8 \text{a} \qquad \qquad 0 < z \le t$	
		6.2.2 Non-conductive portion:	
06	Glass crack	y 1 Z X X	2.5
		y: Chip width x: Chip length z: Chip thickness	
		$y \le L \qquad \qquad x \le 1/8a \qquad \qquad 0 < z \le t$	
		OIf the chipped area touches the ITO terminal, over 2/3 of the ITO must	
		remain and be inspected according to electrode terminal specifications.	4.
		OIf the product will be heat sealed by the customer, the alignment mark not	
		be damaged.	
		6.2.3 Substrate protuberance and internal crack.	
	~	y: width x: length	
		$y \le 1/3L \qquad x \le a$	
	1		
4	N	X	
	1		
		y	
	<u> </u>		

No	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
00	Backlight	8.2 Spots or scratched that appear when lit must be judged. Using	2.5
08	elements	LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or	2.5
		contamination.	
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the seal	2.5
		area on the PCB. And there should be no more than three places.	
		10.5 No oxidation or contamination PCB terminals.	
		10.6 Parts on PCB must be the same as on the production	2.5
10	PCB、COB	characteristic chart. There should be no wrong parts, missing	0.65
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product	
		characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	
		screw hold pad, make sure it is smoothed down.	2.5
		10.9 The Scraping testing standard for Copper Coating of PCB	
			2.5
		X	
	1	$X * Y \le 2mm^2$	
	A	11.1 No un-melted solder paste may be present on the PCB.	2.5
1		11.2 No cold solder joints, missing solder connections, oxidation	2.5
11	Soldering	or icicle.	
	1	11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface Pin	2.5
		(OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin	2.5
		must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limi	ted value	e is set up	accordi	ng to Ro	HS.	,				

- 2. For RoHS compliance, the recommended soldering temperatures for different components are as follows:
- (1) FPC: 300°C, 1-3 seconds
- (2) Backlight AK and metal pin glass: 330°C, 1-5 seconds

Note: Customers should adjust the temperature and duration based on the actual materials used in their soldering process, including the soldering iron, solder paste, and any other components involved.

13.Recommendable Storage

- 1. Place the panel or module in the temperature $25^{\circ}C\pm5^{\circ}C$ and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.



oaule Number :		Page: 1	
1 · Panel Specification :	□ n		
1. Panel Type:	☐ Pass	□ NG ,	
2. View Direction:	☐ Pass	□ NG ,	
3. Numbers of Dots:	☐ Pass	□ NG ,	
4. View Area:	☐ Pass	□ NG ,	
5. Active Area:	☐ Pass	□ NG,	
6. Operating Temperature:	☐ Pass	□ NG,	
7. Storage Temperature:	Pass	□ NG,	
8. Others:			-
2 · Mechanical Specification :			
1. PCB Size:	☐ Pass	□ NG,	
2. Frame Size:	☐ Pass	□ NG,	
3. Materal of Frame:	☐ Pass	□ NG,	
4. Connector Position:	☐ Pass	□ NG,	
5. Fix Hole Position:	☐ Pass	□ NG ,	
6. Backlight Position:	☐ Pass	NG,	
7. Thickness of PCB:	Pass	□ NG ,	
8. Height of Frame to PCB:	Pass	NG,	
9. Height of Module:	Pass	□ NG ,	
10. Others:	☐ Pass	□ NG,	
3 · Relative Hole Size :			
1. Pitch of Connector:	Pass	□ NG,	
2. Hole size of Connector:	☐ Pass	□ NG,	
3. Mounting Hole size:	☐ Pass	□ NG,	
4. Mounting Hole Type:	☐ Pass	□ NG,	
5. Others:	☐ Pass	□ NG,	
4 · Backlight Specification :			
1. B/L Type:	Pass	□ NG,	
2. B/L Color:	Pass	NG,	
3. B/L Driving Voltage (Refer			
4. B/L Driving Current:	☐ Pass	□ NG ,	
5. Brightness of B/L:	Pass	□ NG ,	
6. B/L Solder Method:	Pass	☐ NG ,	
7. Others:	☐ Pass	□ NG ,	

		Page: 2
S · Electronic Characteristics of	Module:	
1. Input Voltage:	☐ Pass	□ NG ,
2. Supply Current:	☐ Pass	□ NG ,
3. Driving Voltage for LCD:	☐ Pass	□ NG ,
4. Contrast for LCD:	☐ Pass	□ NG ,
5. B/L Driving Method:	☐ Pass	□ NG,
6. Negative Voltage Output:	☐ Pass	□ NG ,
7. Interface Function:	☐ Pass	□ NG ,
8. LCD Uniformity:	☐ Pass	□ NG ,
9. ESD test:	☐ Pass	□ NG ,
0. Others:	☐ Pass	□ NG,
Summary:		
Sales signature :		

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Please contact us if you have any questions about the contents of the datasheet.

This may not be the latest version of the datasheet. Please check with us if a later version is available.



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